

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
XINPENG WANG	11/28/2011
HAIYANG ZHANG	11/28/2011
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13324945
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ASSIGNMENT

We, **Xinpeng Wang**, citizen of Beijing, China, having an address of 18 Wen Chang Rd., Economic-Technological Development Area, Daxing District, Beijing 100176, P.R. China, and **Haiyang Zhang**, citizen of Beijing, China, having an address of 18 Wen Chang Rd., Economic-Technological Development Area, Daxing District, Beijing 100176, P.R. China, (hereinafter "Inventors"), represent that we have invented improvements in a new and useful "DOUBLE GATE TRANSISTOR AND METHOD OF FABRICATING THE SAME" (hereinafter the "Invention") set forth in China Patent Application No. 201110282916.7, for which we have executed an application for Letters Patent of the United States of America on the same day as our execution of this Assignment.

SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION, is a Beijing corporation, has a place of business at 18 Wen Chang Rd., Economic-Technological Development Area, Daxing District, Beijing 100176, P.R. China, and desires to acquire the entire right, title and interest in and to the invention, application and Letters Patent to be granted and issued thereon.

For valuable consideration, the receipt and legal sufficiency of all of which we acknowledge, we have sold and do hereby sell, assign, transfer and set over unto SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION, its successors and assigns, the entire right, title and interest in and to the invention and all improvements thereon, in and to the application for Letters Patents thereon, in and to applications pertaining to or based upon the invention and application, including divisional and continuing applications and continuations-in-part, and in and to any and all Letters Patent which may be granted and issued on the invention and applications, or any of them, in the United States of America, its territories and possessions, and in all countries foreign thereto, together with and including all priority rights based upon any and all applications in the United States of America covered by this Assignment.

We also agree that we will, at the request of SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION, execute any and all applications for Letters Patent for the invention, execute any and all other papers and documents and do all other and further lawful acts that SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION may deem necessary or desirable to obtain Letters Patent on the invention, to secure the grant of such Letters Patent and to protect and vest in SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION the undivided interests in the right, title and interest in the invention, applications and Letters Patent.

Docket No. 803-2F-028
 IEE110195-US
 2011-00626-SH-US

We also authorize and empower SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION, its successors and assigns to apply for and obtain, in its or their own names, Letters Patent for the invention before competent International Authorities and in any and all countries foreign to the United States in which applications for Letters Patent can be so made or letters patent so obtained.

Dated 2011.11.28

Xinpeng Wang
 XINPENG WANG

WITNESS

Peter Zhang
 (Type or print name below line)

WITNESS

David Han
 (Type or print name below line)

Dated 2011.11.28

Haiyang Zhang
 HAIYANG ZHANG

WITNESS

Joey Sui
 (Type or print name below line)

WITNESS

Jove Li
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